

SPEC. NO. ( P/N )

**CUSTOMER P/N** 

**ISSUE DATE** 

VERSION

November 28, 2017

A

APPROVED	PREPARED	QA
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## **Diodes Incorporated**

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\*Pb-free

\*RoHS Compliant

\*HF-Halogen Free **\*REACH Compliant** 

\*AEC-Q200 Compliant

# FY1000033Q

VER. A 28-Nov-17

# **VERSION HISTORY**

Version No.	Version Date	Description	Notes	
А	Nov.28,2017	Initial Release		



## FY1000033Q

VER. A 28-Nov-17

## **ELECTRICAL SPECIFICATIONS**

Item	Symbol	Specifications	Units	Notes
Nominal Frequency	Fn	10.000000	MHz	
Mode of Oscillation	MO	AT Cut-Fundamental		
Calibration Load Capacitance	CL	10	pF	
Calibration Tolerance	FL	±20	ppm	at 25°C±3°C
Operating Temperature Range	TR	-40 to +125	°C	
Frequency Stability (Frequency Deviation over the Operating Temperature Range)	F/T	±50	ppm	Reference to the Frequency at 25°C
Operating Drive Level		10	μW	
Maximum Drive Level		100	μW	
Equivalent Series Resistance	ESR	60	Ω	Мах
Shunt Capacitance	C0	5	pF	Мах
Aging at 25°C		±3	ppm	Max, 1st year
Storage Temperature		-55 to +125	°C	
Insulation Resistance		500	MΩ	Min

\* This product doesn't include harmful substance that stipulated by SONY SS-00259 Level 1 and S-AT2-001 Level 1 standard. RoHS Compliant (Pb - Free).



## FY1000033Q

### **AEC-Q200 RELIABILITY TEST SPECIFICATIONS:**

1. Initial

- 1.1 Physical Dimensions: JESD22, Method JB1-100
- 1.2 External Visual: MIL-STD-883, Method 2009
- 1.3 Freq. Vs. Temperature: Per Specification/Datasheet

#### 2. Mechanical

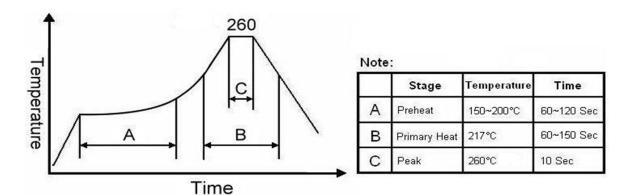
- 2.1 Mechanical Shock: MIL-STD-202 Method 213
- 2.2 Vibration: MIL-STD-202 Method 204
- 2.3 Solderability: J-STD-002
- 2.4 Board Flex: AEC Q200-005
- 2.5 Terminal Strength (SMD): AEC Q200-006

#### 3.Environmental

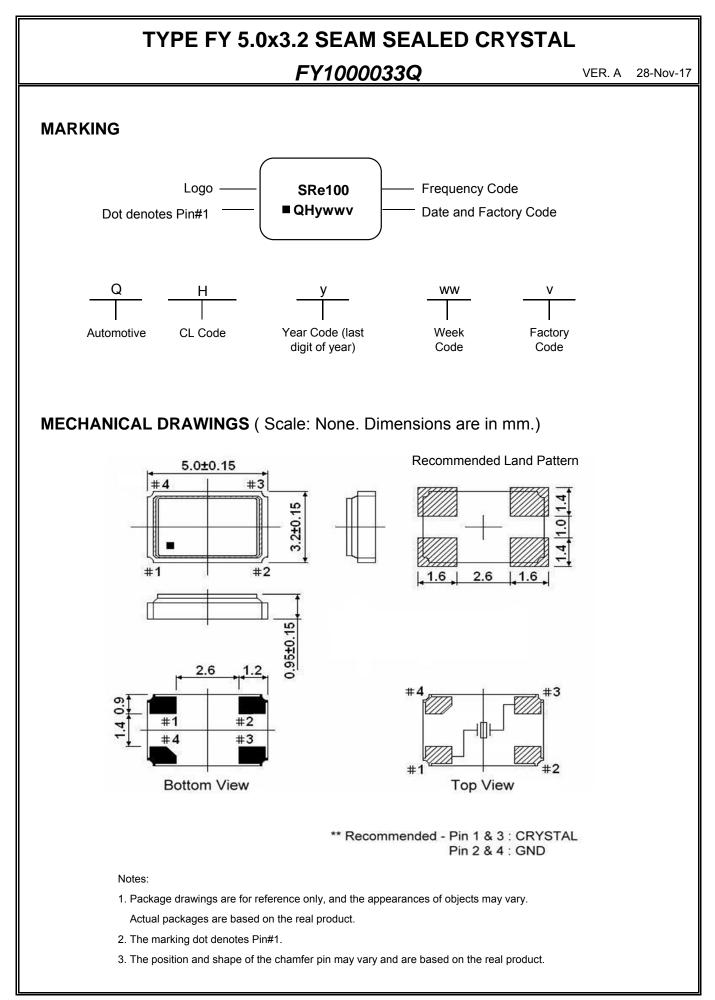
- 3.1 Temp Cycle: JESD22, Method JA-104
- 3.2 Resistance to Solder Heat: MIL-STD-202 Method 210
- 3.3 High Temperature Operating Life: MIL-STD-202, Method 108
- 3.4 High Temp Exposure: MIL-STD-202, Method 108
- 3.5 High Temp & High Humidity: MIL-STD-202, Method 103
- 3.6 Thermal Shock: MIL-STD-202, Method 107

### SUGGESTED IR REFLOW PROFILE

\*As per IPC-JEDEC J-STD-020D





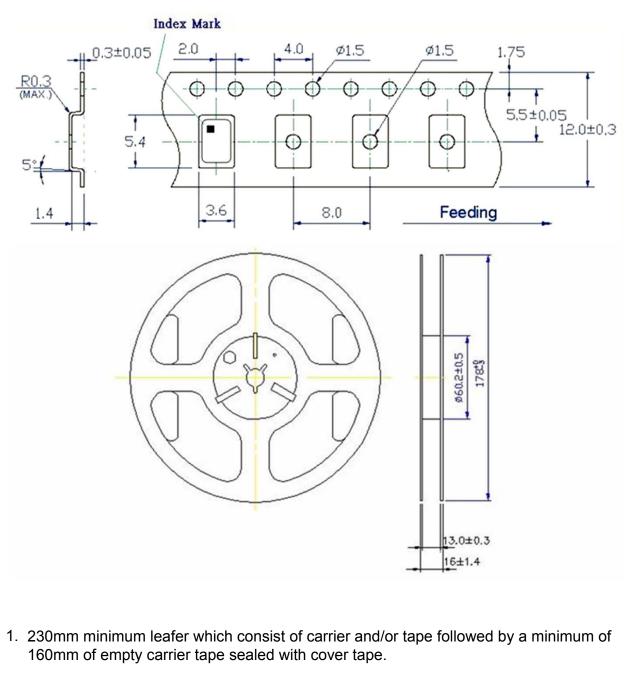




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Tape & Reel



2. 160mm minimum trailer of empty carrier tape sealed with cover tape.



